

Asia Tin Week 2025

Hong Kong China

19-21 November 2025



Co-host: Yunnan Tin Group (Holding) Co., Ltd.



Co-host: Honghe Prefecture Hongtou Industrial and Commercial Co., Ltd.

Wednesday, 19th November 2025

10:00-18:30 Conference Registration

18:00-20:30 Welcome Reception

Thursday, 20th November 2025

Session 1 – Welcome to Asia Tin Week 2025

09:00	Setting the global agenda for a sustainable and resilient tin industry	Helen Prins, CEO, International Tin Association
	Highlighting Hong Kong's strategic role as a global metals hub and gateway to Asia	Joseph Chan, Under Secretary for Financial Services and the Treasury Bureau, the

	Government of Hong Kong SAR
Remarks from the world's leading tin producer on strengthening industry collaboration and innovation	Shouli Han, General Manager, Yunnan Tin Group (Holding) Co., Ltd.
China's Nonferrous Metal Futures: Powering Stability in the Global Metals Industry	Feng Lu, Vice President, Shanghai Futures Exchange
Sharing perspectives from industry partner on responsible growth and China's evolving tin supply chain	Xiaoning Zhang, President, Guangxi Huaxi Nonferrous Metals

Session 2 – Keynote & Market Outlook

09:40	Competition, Synergy, and Cooperation: The Future of the Tin Industry in a Transforming Global Landscape	Xuesen Chen, Vice President, China Nonferrous Metals Industry Association (CNIA)
	Global Macro Trends to 2026: Navigating Economic Shifts, Geopolitical Tensions and Policy Risks	Chang Shu, Chief Asia Economist, Bloomberg
	Global Tin Market Outlook: Tin in the Crosswinds	Tom Langston, Senior Analyst, ITA
11:10	<i>Networking break</i>	

Session 3 – Panel: Asia's Pivotal Role in Building a Resilient Global Tin Supply Chain

11:25	- LME Tin Warehouse in Hong Kong – Turning Ambition into Action - China's Tin Futures Market – A Decade of SHFE Tin Futures: Review and Outlook - Asian Tin Futures Markets – Elevating Tin's Financial Presence - Producers' Perspective – Toward a Stable and Sustainable Tin Ecosystem	Moderator: Tiger Shi, CEO of Bands Financial Ltd. Panelist: Yang Liu, LME Kun Xiao, SHFE Xiongjun Chen, YTC PT Timah Tbk, TBC Bonnie Liu, GF Futures (HK) Co., Ltd. Benjamin Wong, InvestHK
12:30	<i>Lunch</i>	<i>Sponsored by GF Futures (Hong Kong) Co., Ltd.</i>

Session 4 – Securing Tin Supply: A Global Focus with Asia at the Core

14:00	Opening Insights – Global Supply Risks and New Project Pipeline	Huanbo Qin, Analyst, ITA
	China and Asia Tin Markets Outlook: Anchoring Stability Amid Global Volatility	Zhao Li, Senior Analyst, YTC
	China's Tin Industry for the Future: An Innovation-Driven Development Strategy with Yunnan at Its Core	Jinqiu Tai, Jucheng Industry
	Navigating Indonesia's Policy Shifts: Industry at a Crossroads	Rani Febrianti, MIND ID
	Strategy for Circular Tin in Thailand: Scaling Secondary Production	Jonathan Lund, Thaisarco

Session 5 – Tin Industry in Transition: ESG Expectations, Compliance, and Impact

15:45	Downstream Voice – ESG in Practice: What Buyers Expect and Why It Matters	Kim Vu, Applied Materials, TBC
	Navigating Local and Global Challenges: the ITSCI Programme's Strengthened Support for Responsible 3T Mineral Sourcing from Central Africa"	Mickaël Daudin, iTSCI
	Bridging Upstream and Downstream Through Collaborative ESG Initiatives and the Tin Code	Ryan Wen, ITA

16:30 *Networking break*

Session 6 – CEO Panel: Charting the Future of Tin in a Divided World

16:45	- Rethinking Tin's Role in the Global Critical Minerals Narrative - Upstream Realities: Pressure on Supply, Urgency of New Resource Development, new pathway forward under low TC for smelters - From Fragility to Resilience: Managing Global Disruptions and Building Adaptive Supply Chains - Geopolitics and Regional Realignment: What They Mean for Tin Trade and Investment - Substitution and Innovation: Balancing Risk and Unlocking New Tin Applications - Market Drivers: How Digitalization, Decarbonization, and the Energy Transition Will Shape Tin Demand	Moderator — Helen Prins, CEO, ITA Panelists: Luke Liu, YTC Mariano Pero, OMSA PT Timah, TBC Guangxi Huaxi Qiandao Lijue Wu, Ximei and Farwei
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- Towards Sustainable and Value-Added Growth: Building the Tin Industry of Tomorrow

18:00 **Day ends**
19:30 *Welcome Dinner*

Friday, 21st November 2025

Session 7 – Tin in Solder: Innovation, Performance and Market Trends

09:00	The Future of Tin-Based Solder: Analysis of Trends and Challenges	Chunfang Zi, CTO, Vital New Material
	The New Frontier in Electronic Materials: FAST Solder Paste	Fen Chen, Indium Corp (Suzhou)
	Panel Discussion: Tin's Future in Solder and Beyond	TBC

10:15 *Networking break*

Session 8 – Innovation Spotlight: Sustainable Tin Technologies

10:30	Driving Innovation: ITA's Technology Focus Today and Tomorrow	Georgia Laurie, ITA
	Low Carbon Production Technologies for Tin	Jon Bøhmer, Huma Group AS
	Hydrogen reduction of cassiterite concentrate and options for sustainable tin production	Alexandros Charitos, INEMET and TUBAF
	Panel Discussion: Innovation in Sustainable Tin Technologies	TBC

12:00 *Lunch*

13:30 **Day ends**

13:30- **Social Networking -Sightseeing tour (55 US\$ fee applies)**

20:00 **Hong Kong's Tai O Fishing Village**——Tai O-one of Hong Kong's last traditional fishing ports, is a place where crisscrossing waterways replace bustling streets and stilt houses built along the water exude a homely atmosphere.